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LTR		DESCRIPTION										DAT	E (YF	R-MO-E	DA)	Al	PPRO	WED								
A	Page :	Change to military drawing format. Page 1, change title. Page 2, change generic number and circuit function. Page 6, correct switching test circuit. Page 9, correct vendor similar part number.												86	0ct	20		A	14	, v	K					
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DESC FORM 193-1 SEP 87

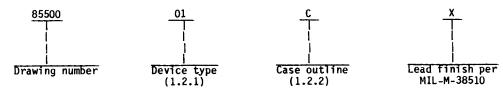
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SCO	

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with $1.\overline{2.1}$ of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part number. The complete part number shall be as shown in the following example:



1.2.1 Device type. The device type shall identify the circuit function as follows:

Device type	Generic number	Circuit
01	UH -508	Quad 2-Input AND driver high-output voltage and current

1.2.2 <u>Case outlines</u>. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:

Outline letter	Case outline
C D	D-1 (14-lead, $.785$ " x $.310$ " x $.200$ "), dual-in-line package F-2 (14-lead, $.390$ " x $.260$ " x $.085$ "), flat package

1.3 Absolute maximum ratings.

```
7.0 V dc
                      5.5 V dc
Output off-state voltage - - - - - - - - - - -
                      100 V dc
500 mA
                      -65°C to +150°C
+300°C
+150°C
See MIL-M-38510, appendix C
Thermal resistance, junction to ambient (\theta_{JA}):
 90°C/watt
                      140°C/watt
```

1.4 Recommended operating conditions.

Supply voltage (V _{CC})	4.5 V to 5.5 V
Current into any output (on-state)	250 mA maximum
Ambient operating temperature (TA)	-55°C to +125°C
Minimum high level input voltage (V_{IH})	2.0 V
Maximum low level input voltage (VIL)	0.8 V

STANDARDIZED MILITARY DRAWING	SIZE A		85500	
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2. APPLICABLE DOCUMENTS

2.1 Government specification and standard. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510

- Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883

- Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

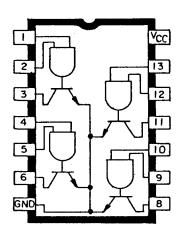
3. REQUIREMENTS

- 3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.
- 3.2.1 Logic diagram and terminal connections. The logic diagram and terminal connections shall be as specified on figure 1.
- 3.2.2 <u>Switching circuit and waveforms</u>. The switching circuit and waveforms shall be as specified on figure 2.
 - 3.2.3 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.
- 3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full ambient operating temperature range.
- 3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein.
- 3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.
- 3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

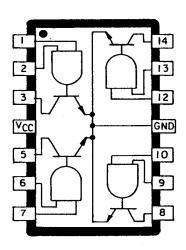
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TABLE I. Electrical performance characteristics.								
Test	 Symbol 	Conditions Conditions -55°C < T _A < +125°C unless otherwise specified	 Group A subgroups 		nits Max 	Unit		
Input current High	I IN(1)	 Other input Driven input: 2.4 V = 0 V 5.5 V	1,2,3 1,2,3	 	40 1,000	μА		
Input current Low	1 IN(0)	Other input = 4.5 V, Driven input: 0.4 V V _{CC} = 5.5 V, V _{OUT} = 100 V	1,2,3		-800	μА		
Output reverse current	I OFF	Other input = V _{CC} ,	1,2,3	 	 100 	μА		
Output voltage Low	I I VON		1,3 1,3		0.5	٧		
	 				0.6			
Level supply current, High	I _{CC(1)}		1		30	mA		
Level supply current, Low	I _{CC} (0)	T _A = +25°C	1		106			
Propagation delay time, "Turn-on"	t _{pdON}	V _S = 100 V, C _L = 15 pF	9,10,11		500	ns		
Propagation delay time, "Turn-off"	 t _{pd0FF} 	 V _{CC} = 5.0 V, R _L = 670 ohm	9,10,11		750			

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Case C

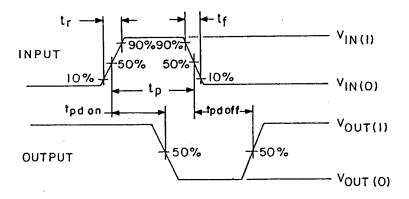


Case D

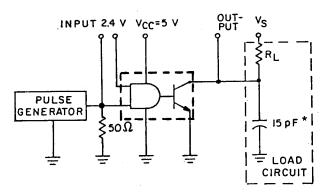
FIGURE 1. Logic diagram and terminal connections.

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DAYTON, OHIO		REV A	PAGE 5

DESC FORM 144A APR 83



Wave forms



Input pulse:

VIN (0) = 0V VIN (1) = 3.5V tf = 7 ns tr = 14 ns tp = 1 us PLR = 500 KHZ V_S = 100 V

*Includes probe and test fixture capacitance

Test circuit

FIGURE 2. Switching circuit and waveforms.

DEFENSE ELECTRONICS SUPPLY CENTER	SIZE A	14933	NO.	DWG NO. 85500	
DAYTON, OHIO		REV	В	PAGE	6

DESC FORM 144A

APR 83

- 3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).
- 3.8 <u>Verification and review.</u> DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
 - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).
- 4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125^{\circ}C$, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method) 5005, table I)
Interim electrical parameters (method 5004)	
Final electrical test parameters (method 5004) 	1*, 2, 3, 9
Group A test requirements (method 5005) 	 1, 2, 3, 9,
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

^{*} PDA applies to subgroup 1.

STANDARDIZED MILITARY DRAWING	SIZE A	,	85500	
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET	7

^{**} Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-SID-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
 - 4.3.1 Group A inspection.
 - a. Tests shall be as specified in table II herein.
 - b. Subgroups 4, 5, 6, 7, and 8 in table I, method 5005 of MIL-STD-883 shall be omitted.
 - 4.3.2 Groups C and D inspections.
 - a. End-point electrical parameters shall be as specified in table II herein.
 - b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125$ °C, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.
 - 5. PACKAGING
- 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.
 - 6. NOTES
- 6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
- 6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.

STANDARDIZED MILITARY DRAWING	SIZE A			85500	
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVI	SION LEVEL	SHEET	8

6.4 Approved sources of supply. Approved sources of supply are listed herein. Additional sources will be added as they become available. The vendors listed herein have agreed to this drawing and a certificate of compliance (see 3.8) has been submitted to DESC-ECS.

Military drawing part number	Vendor CAGE number	Vendor similar part number <u>1</u> /		
8550001CX 8550001CX	56289	UHD508H/883C SG508H/883B		
8550001DX	56289 	UHC508J/883C		

1/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number 56289

Sprague Electric Company 115 Northeast Cutoff Worcester, MA 01607

Vendor name and address

34333 Silicon General Incorporated 11861 Western Avenue Garden Grove, CA 92641

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DAYTON, OHIO 45444

SIZE A 85500

REVISION LEVEL SHEET 9